

## Ratings Maximum operating voltage: 48 V **Connector Current Capacity** Maximum operating current: 6.5 A (not mated under load) 10.0 **Operating Temperature Range** -25 to 85 °C, relative humidity of 85% or less 9.0 Max Current Materials (1)Insulator: PBT, black 8.0 (2)Cover: PBT, black (3)Center Pin: copper alloy, silver plated v (4)Terminal: brass, silver plated Upper Temperature Limit 85 7.0 **Operating Current** (5) Spring contact: phosphor bronze, silver plated Current (Amps) 6.0 Electrical Requirements Dielectric strength: 1 min @ 500 Vac Insulation resistance: 100 MQ @ 500 Vdc minimum 5.0 Contact resistance: 50 mQ maximum Mechanical Requirements 4.0 Insertion force: 0.3-1.8 kgf (Derated) Withdrawal force: 0.3-1.8 kgf Life cycle: 5000 mating cycles while maintaining contact resistance: 100 m $\Omega$ maximum, withstand voltage: 500 Vac, 1 min Operating 3.0 Area Terminal strength: 150 gf applied to the terminal for 15 seconds in any direction while maintaining electrical characteristics and 2.0 without damage or excessive looseness of terminals Soldering 1.0 Solderability: 75% minimum coverage when terminals dipped 2mm in 245 ±5 °C solder bath for 3 ±0.5 seconds Solder bath durability: no deformation when immersed in 255 ±5 °C 0.0 up to surface of the board 1.6 mm for 5 seconds or less 35.0 45.0 55.0 65.0 75.0 85.0 95.0 Solder iron durability: no deformation when exposed to 350 ±10 °C Ambient Temperature (°C) for $3 \pm 0.5$ seconds Testing based on IEC 60512-5-2. Max current curve generated with isolated test article under controlled environmental conditions, **Environmental Requirements** Cold test: -25 ±3 °C for 48 hours without deformation and does not take into account external factors such as housings, mating cables, or other circuitry. Operating current curve (derated by 20% of maximum values) accounts for external factors, and manufacturing variation. Heat test: 85 ±2 °C, relative humidity 45-85% for 48 hours without deformation Humidity test: 40 ±2 °C, relative humidity 90-95% for 48 hours **Wave Soldering Temperature Profile** without deformation 245 °C peak (5 seconds max) Temperature (°C) Pb - Free Flow Profile Solder temperature: 245 °C 120 °C Time: 5 seconds maximum Pre-heat: 100 ~120°C 100 °C Time: 70 seconds maximum Pre-heat Measure point: surface of the solder leads 70 seconds (max) Time (S) Povision: Date: Description Droparod Notor

Revision:	Date:	Description:	Prepared:		Notes:					
А	9/26/2018	Initial release	AG Digitally signed by AG Date: 2018.09.27 13:39:29-07'00'		Function test: no open, no short circuit, no		TENSILITY			
			Verified: RS Dimensio	Digitally signed by RS Date: 2018.09.27 15:21:01 -07'00'	intermittent		tel 1.541.323.3228 800 877.670.7118 fax 1.541.323.4202 web tensility.com			
			millimete Tolerance < 1.0: ±	es: 0.1 mm	Description: Connector, dc jack 5.5x2.1 mm, PCB mount, 180°, silver plated, thru hole		Size: A	Part number: 54-00148		
			1.0 to 10.0 > 10.0: ±	0: ± 0.2 mm 0.3 mm			Scale:	5:1	$\bigcirc \square$	Sheet 2 of 2
		5	4		3	2				1